



RD Number: RD195

RD Title: TC78B041FNG/TPD4204F Fan Motor Drive Board BOM

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package	Not Mount
1	IC1	1	TC78B041FNG	TC78B041FNG	TOSHIBA	Brushless Motor Controller IC	SSOP30	
2	IPD	1	TPD4204F	TPD4204F	TOSHIBA	Intelligent Power Device High Voltage 3-phase motor driver	SSOP30	
3	Q2	1	RN1403	RN1403	TOSHIBA	NPN Transistor with built in	SOT-346	
4	D1	1	CRG04	CRG04	TOSHIBA	Rectifier Diode 600V/1A	S-FLAT	
5	ZD1	1	CRZ18	CRZ18	TOSHIBA	Zener Diode 18V/0.7W	S-FLAT	
6	PTC	1	PTC	—	—	PTC Resistor (Bottom side)	R 0603	
7	HU	1	HW101A	—	—	Hall element (Bottom side)		
8	HV	1	HW101A	—	—	Hall element (Bottom side)		
9	HW	1	HW101A	—	—	Hall element (Bottom side)		
10	R1	1	0.22Ω 0.25W	—	—	Chip Resistor	R 1206	
11	R2	1	100Ω	—	—	Chip Resistor	R 0603	
12	R3	1	330Ω	—	—	Chip Resistor	R 0603	
13	R4	1	330Ω	—	—	Chip Resistor	R 0603	
14	R5	1	22kΩ	—	—	Chip Resistor	R 0603	
15	R6	0	Not mount	—	—	Chip Resistor	R 0603	✓
16	R7	1	0Ω	—	—	Chip Resistor	R 0603	
17	R8	1	12kΩ	—	—	Chip Resistor	R 0603	
18	R9	1	10kΩ	—	—	Chip Resistor	R 0603	
19	R10	0	Not mount	—	—	Chip Resistor	R 0603	✓
20	R11	1	0Ω	—	—	Chip Resistor	R 0603	
21	R12	0	Not mount	—	—	Chip Resistor	R 0603	✓
22	R13	1	0Ω	—	—	Chip Resistor	R 0603	
23	R14	0	Not mount	—	—	Chip Resistor	R 0603	✓
24	R15	1	0Ω	—	—	Chip Resistor	R 0603	
25	R16	1	1kΩ	—	—	Chip Resistor	R 0603	
26	R17	1	10kΩ	—	—	Chip Resistor	R 0603	
27	R18	1	10kΩ	—	—	Chip Resistor	R 0603	
28	R19	1	5.1kΩ	—	—	Chip Resistor	R 0603	
29	R20	1	120kΩ	—	—	Chip Resistor	R 0603	
30	R21	1	0Ω	—	—	Chip Resistor	R 0603	
31	R22	0	Not mount	—	—	Chip Resistor	R 0603	✓
32	R23	1	0Ω	—	—	Chip Resistor	R 0603	
33	R24	1	0Ω	—	—	Chip Resistor	R 0603	

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